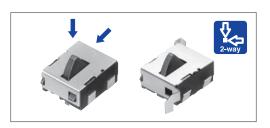


Compact Two-way Operation Type





3.5×2.8×height 1.5mm compact detector switch detects from both vertical and horizontal directions.



Typical Specifications

Ite	ms	Specifications		
Rating (max.) / (min.) (Resistive load)		1mA 5V DC / 50μA 3V DC		
Contact resistan (Initial /After ope		2 Ω max. / 5 Ω max.		
Operating force		0.4N max.		
On anation life	Without load	50,000cycles		
Operating life	With load	50,000cycles (1mA 5V DC)		

Detector	
Slide	

Push

Rotary

Encoders

Power

Dual-in-line

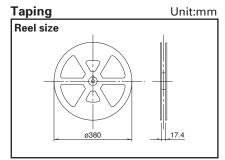
Package Type

TACT Switch™

Product Line

Polos	Poles Positions Terminal		Frame	Location lug	Minimumorder unit (pcs)		Product No.	Drawing No.
rules	FUSILIUIIS	type	Frame	Location lug	Japan	Export	Froduct No.	Drawing No.
			Without	With		00 12.000	SPVM110100	1
1	1	For PC board	terminal	Without	2 000		SPVM110200	
'	'	(Reflow)	With	With	3,000	12,000	SPVM210100	2
			terminal Without		SPVM210200			

Packing Specifications



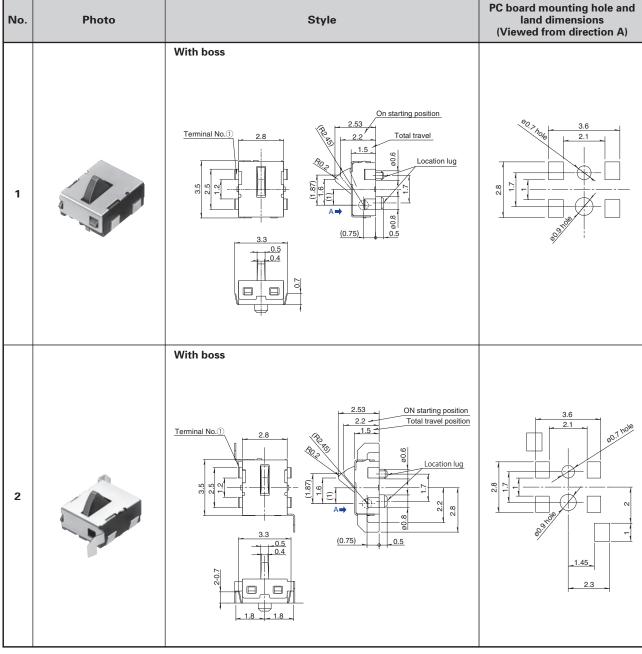
Numb	er of packages	(pcs.)	Tape width	Export package measurements (mm)	
1 reel	1 case / Japan	1 case / export packing	(mm)		
3,000	6,000	12,000	16	417 × 409 × 139	

SPVM

Dimensions

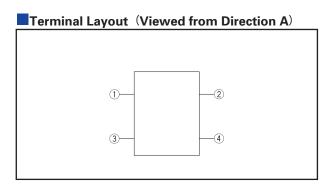
Compact Two-way Operation Type

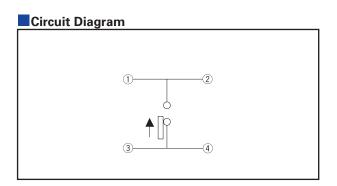
No. **Photo** Style Detector With boss Slide Push On starting position **Rotary** Terminal No.1 **Encoders** Location lug Power 1 Dual-in-line Package Type TACT Switch™ With boss



Note

Dimensions drawing is for type with location lugs.





Unit:mm

When applying the soldered frame terminals as earth terminals, place No.3 and No.4 terminals on the same ground.

Detector Switches

■ List of Varieties (General-purpose Type)

		General-purpose Type							
S	eries	SPVS	SPVN	SPVP	SPVT	SPVM	SPVR		
Photo		X		- Company					
Operation type		Two	Two-way			Two-way			
	W	3.5	3.8	3.5	5.6	2.8	3.6		
Dimensio (mm)	ons D	3.3	3.6	5.65	4.7	3.5	4.2		
	Н		1	1.2	1.9	1.5	1.2		
	g temperature ange			-40°C to) +85°C				
Auton	notive use	•	•	•	•	•	•		
Life cycle	e (availability)	* 3	* 3	★1	★3	★3	★3		
Poles	/ Positions			1,	/1				
Ratin (Resis	g(max.) stive load)	1mA 5V DC		50mA 20V DC		1mA 5V DC			
Ratir (Resis	ng (min.) stive load)	50μA 3V DC		100µA 3V DC		50μA 3V DC	100μA 3V DC		
	Operating life without Load	50,000cyclo	es 5 Ω max.	50,000cycles 10 Ω max.	100,000cycles 1 Ω max.	50,000cycles 5 Ω max.			
Durability	Operating life with Load Rating (max.) (Resistive load)	50,000cycles 5 Ω max.		50,000cycles 10 Ω max.	100,000cycles 1 Ω max.	50,000cycles 5 Ω max.			
	Initial contact resistance	itial contact 2.0 may 5.0 may 500m 0 may		2Ω max.	3Ω max.				
Electrical performance	Insulation resistance	100MΩ min. 1			1. 100V DC				
	Voltage proof		100V AC for 1 minute						
Mechanical	Terminal strength		0.5N for 1minute			1N for 1minute	0.5N for 1minute		
performance	Actuator strength		5N		10N 5N		2N		
	Cold −40±2°C for 96h								
Environmental performance	Dry heat								
	Damp heat	40 ± 2°C, 90 to 95% RH for 96h							
Opera	ition force	0.35N	I max.	0.55N max.	0.4N	max.	0.35N max.		
ı	Page	13	15	17	18	21	23		

Note

Detector

Slide

Push

Rotary

Encoders

Power

Dual-in-line Package Type

TACT Switch[™]

indicates applicability to all products in the series.

Detector Switches Soldering Conditions

Example of Reflow Soldering Condition

1. Heating method: Double heating method with infrared heater.

2. Temperature measurement: Thermocouple 0.1 to 0.2ϕ CA(K) or CC(T) at soldering portion (copper foil surface).

A heat resisting tape should be used for fixed measurement.

3. Temperature profile

Detector

Slide

Push

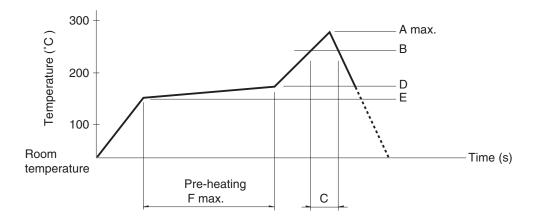
Rotary

Encoders

Power

Dual-in-line Package Type

TACT Switch™



Series (Reflow type)	A (℃) 3s max.	B (℃)	C (s)	D (℃)	E (°C)	F(s)
SPPB	250	230	40			120
SPPW8	250		35			
SPVE			40			
SPVL				180	150	
SPVM						
SPVN						
SPVP	260					
SPVR	260					
SPVS						
SPVT						
SSCM						
SSCQ						
SPVQC	250					

Notes

- 1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, surface depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Reference for Hand Soldering

Series	Soldering temperature	Soldering time	
SPVS, SPVN, SPVP, SPVT, SPVM, SPVR, SPVE, SPPW8,SSCQ, SSCM, SPVL, SSCT, SPVQC	350 ± 5℃	3s max.	
SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SSCN, SPVQA	300 ± 10℃	3 +1 / 0s	
SPPB	350 ± 5℃	5s max.	
SSCF	350 ± 10℃	3 +1 / 0s	

Reference for Dip Soldering

(For PC board terminal types)

/							
	Ite	ms	Dip soldering				
Series	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion			
SSCT, SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SPVQA	100 ± 10℃	60s max.	260 ± 5°C	5 ± 1s			
SPPW8, SPPB	100 °C max.	60s max.	255 ± 5℃	5 ± 1s			
SSCF	_		260 ± 5°C	5 ± 1s			